

TECHNICAL DATA Data Sheet 4098, Rev. D.1

Three-Phase IGBT BRIDGE, With Gate Driver and Optical Isolation

DESCRIPTION: A 600 VOLT, 80 AMP, THREE PHASE IGBT BRIDGE

ELECTRICAL CHARACTERISTICS PER IGBT DEVICE

(Tj=25°C UNLESS OTHERWISE SPECIFIED)

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
IGBT SPECIFICATIONS					
Collector to Emitter Breakdown Voltage $I_C = 250 \mu A, V_{GE} = 0 V$	BV _{CES}	600	-	-	V
Continuous Collector Current $T_C = 2$ $T_C = 9$		-	-	80 70	А
Pulsed Collector Current, 1mS	I _{CM}	-	-	170	А
Gate to Emitter Voltage	V_{GE}	-	-	+/-20	V
Gate-Emitter Leakage Current , V _{GE} = +/-20V	I _{GES}	-	-	+/- 100	nA
Zero Gate Voltage Collector Current $V_{CE} = 600 \text{ V}, V_{GE} = 00 \text{ T}_{i} = 25^{\circ}\text{C}$ $V_{CE} = 480 \text{ V}, V_{GE} = 00 \text{ T}_{i} = 125^{\circ}\text{C}$	I _{CES}	-	-	1 10	mA mA
Collector to Emitter Saturation Voltage, $T_C = I_C = 60A$, $V_{GE} = 15V$,	25 °C V _{CE(SAT)}	-	1.7	2.0	V
Maximum Thermal Resistance	$R_{ heta JC}$	-	-	0.45	°C/W
Brake IGBT SPECIFICATIONS					
Continuous Collector Current $T_C = 2$ $T_C = 9$		-	-	40 25	А
Pulsed Collector Current, 0.5mS	I _{CM}	-	-	120	А
Brake Resistor SPECIFICATIONS	·				
Maximum Continuous power dissipation	Pd			2	watt
Impulse Energy				80	Joules
Maximum operating Junction Temperature	T _{jmax}	-40	-	150	°C
Maximum Storage Junction Temperature	T _{jmax}	-55	-	150	°C

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Over-Temperature Shutdown					
Over-Temperature Shutdown	Tsd	100	110	120	°C
Over-Temperature Output	Tso		10		10mV/°C
Over-Temperature Shutdown Hysteresis			20		°C

ULTRAFAST DIODES RATING AND CHARACTERISTICS					
Diode Peak Inverse Voltage	PIV	600	-	-	V
Continuous Forward Current, T _C = 90 ^O C	I _F	-	-	60	А
Forward Surge Current, t _p = 10 msec	I _{FSM}	-	-	300	А
Diode Forward Voltage, $I_F = 60A$	V _F	-	1.4	1.7	V
Diode Reverse Recovery Time (I _F =60A, V _{RR} =300V , di/dt=200 A/μs)	t _{rr}	-	90	160	nsec
Maximum Thermal Resistance	R _{eJC}	-	-	0.8	°C/W
Gate Driver	,				
Supply Voltage	VCC	10	15	20	V
Input On Current	HIN, LIN	2		5.0	mA
Opto-Isolator Logic High Input Threshold	I _{th}	-	1.6	-	mA
Input Reverse Breakdown Voltage	BV _{in}	5.0	-	-	V
Input Forward Voltage @ I _{in} = 5mA	V _F	-	1.5	1.7	V
Under Voltage Lockout	VCCUV	11.5	-	12.5	V
ITRIP Reference Voltage (1)	Itrip-ref	2.9	3.0	3.1	V
Input-to-Output Turn On Delay	t _{ond}	-		800	nsec
Output Turn On Rise Time	t _r	-		100	
Input-to-Output Turn Off Delay		-			
Output Turn Off Fall Time	t _{offd}	-		1000	
@ VCC=300V, IC=50A, T _C = 25	t _f			100	
Input-Output Isolation Voltage	-	1000	-	-	V

⁽¹⁾ ITRIP Cycle-by cycle current limit is internally set to 70A peak. The set point can be lowered by connecting a resistor between ltrip-ref and Gnd. The set point can be increased by connecting a resistor between ltrip-ref and +5V ref

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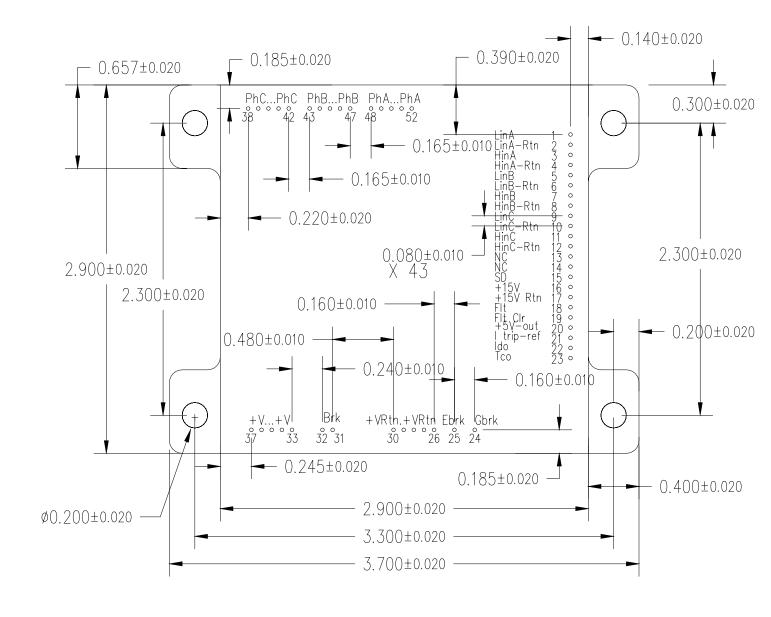
Pin Description

Pin Number	Function	Pin Number	Function		
1	Isolated Input for Low-side IGBT of Phase A	17	+15V Rtn (Signal Ground)		
2	Return for Input at 1	18	Fault Output ⁽³⁾		
3	Isolated Input for High-side IGBT of Phase A	19	Fault Clear Input (3)		
4	Return for Input at 3	20	+5V Output		
5	Isolated Input for Low -side IGBT of Phase B	21	Over-Current Trip Set point (3)		
6	Return for Input at 5	22	DC Bus Current Output with Total Gain of 0.0365 V/A		
7	Isolated Input for High-side IGBT of Phase B	23	Case Temperature Output with a gain of 0.010 V/°C		
8	Return for Input at 7	24	Brake IGBT Gate Input		
9	Isolated Input for Low-side IGBT of Phase C	25	Brake IGBT Emitter Input. This input is internally connected to Signal Ground		
10	Return for Input at 9	26 to 30	DC Bus return		
11	Isolated Input for High-side IGBT of Phase C	31 , 32	Brake Resistor Terminal. Brake Resistor Shall be Connected Between These Terminals and +VDC		
12	Return for Input at 11	33 to 37	DC Bus "+VDC" input		
13	NC	38 to 42	Phase C output		
14	NC	43 to 47	Phase B output		
15	SD ⁽³⁾	48 to 52	Phase A output		
16	+15V Input	Case	Isolated		

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Package Drawing Top View:



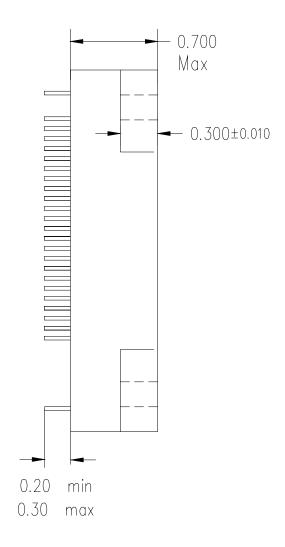
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Package Drawing Side View:



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Application Notes:

a- Shutdown Feature:

- 1- SD is a dual function input/output, active low input. It is internally pulled high. As a low input shuts down all IGBTs regardless of the Hin and Lin signals.
- **2-** SD is also internally activated by the over-temperature shutdown, over-current limit, undervoltage shutdown, and desaturation protection.
- **3-** Over-temperature shutdown, and over-current limit are not latching features.
- **4-** Under-voltage shutdown is automatically reset after 300 msec once the VCC rises above the threshold limit.
- 5- Desaturation shutdown is a latching feature and internally reset after 300 msec.
- **6-** When any of the internal protection features is activated, SD is pulled down.
- **7-** SD can be used to shutdown all IGBTs except the brake IGBT by an external command. An open collector switch shall be used to pull down SD externally.
- **8-** Also, SD can be used as a fault condition output. Low output at SD indicates a fault situation.

b- Fault Output Feature:

- **1-** Pin 18 Flt is a dual function pin. It is internally pulled high. If pulled down, it will freeze the status of all the six IGBTs regardless of the Hin and Lin signals
- **2-** Pin 18 as an output reports desaturation protection activation. When desaturation protection is activated a low output for about 9 μsec is reported.
- 3- If any other protection feature is activated, it will not be reported by Pin 18.

c- Fault Clear Output:

- **1-** Pin 19 is a fault clear input. It can be used to reset a latching fault condition, due to desaturation protection.
- **2-** Pin 19 is internally pulled down. A latching fault due to desaturation can be cleared by pulling high this input.
- **3-** An internal fault clear is activated after 300 msec delay. If desired to clear the fault earlier, this input can be used.

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Cleaning Process:

Suggested precaution following cleaning procedure:

If the parts are to be cleaned in an aqueous based cleaning solution, it is recommended that the parts be baked immediately after cleaning. This is to remove any moisture that may have permeated into the device during the cleaning process. For aqueous based solutions, the recommended process is to bake for at least 2 hours at 125°C.

Do not use solvents based cleaners.

Recommended Soldering Procedure:

Signal pins 1-24: 210C for 10 seconds max

Power pins 25 to 52: 260C for 10 seconds max. Pre-warm module to 125C to aid in power pins soldering.

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